

## 20-3065 NC LOW VISCOSITY POTTING & ENCAPSULATING RESIN

#### **DESCRIPTION:**

20-3065 NC is a general purpose, low viscosity epoxy potting and encapsulating resin system. This is a 100% solids system. It therefore does not contain any solvents.

20-3065 NC is a filled system resulting in excellent dimensional stability and extremely low shrinkage. 20-3065 NC is characterized by exceptional resistance to impact, vibration, and thermal shock. In addition, this versatile resin system is machinable; can be cut, drilled and tapped. It is ideal for use with meter mix dispensing equipment.

20-3065 NC has found wide acceptance as a potting and encapsulating compound for applications such as transformers, coils, chokes, solenoids, resistors, modules, micro circuitry, resistors, capacitors, etc...

#### **TYPICAL SPECIFICATIONS:**

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Viscosity, Resin, 25°C cps	9,000
Pot Life w/ Catalyst 30, @ 25°C	> 4 Hours
Pot Life w/ Catalyst 150, @ 25°C	60 Minutes
Pot Life w/ Catalyst 190, @ 25°C	45 Minutes
Specific Gravity, 25°C	1.56
Hardness, Shore D	88
Cure Shrinkage, in/in	0.002
Tensile Strength, psi	7,000
Compressive Strength, psi	15,600
Operating Temp. Range, °C	<sup>-</sup> 70 to <sup>+</sup> 180
Dielectric Strength, V/mil	460
Dielectric Constant at 100 Hz	4.52
Volume Resistivity, ohm cm, 25°C	$3.99 \times 10^{14}$
Dissipation Factor, 100 Hz	0.01
Thermal Conductivity, W/m- °K	0.65
Thermal Expansion Coefficient,°C	40 x 10 <sup>-6</sup>
Flexural Strength, psi	12,500
Izod Impact, ft-lb/in.	0.26
Flexural Modulus, psi	.2 x 10 <sup>6</sup>

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#### **INSTRUCTIONS FOR USE:**

#### **ROOM TEMPERATURE CURING WITH CATALYST 190**

Catalyst 190 is designed for applications requiring a room temperature curing system with excellent physical and electrical insulation properties.

- 1. By weight, thoroughly mix 8 parts Catalyst 190 to 100 parts 20-3065 resin.
- 2. Pour and allow to cure according to one of the following schedules:

25°C 16-24 Hours

45°C 4-6 Hours

65°C 1-2 Hours

### **ROOM TEMPERATURE CURING WITH CATALYST 150**

Catalyst 150 is low in viscosity and has a long pot life. It is excellent for thermal shock, impact resistance and low temperature properties.

- 1. By weight, thoroughly mix 20 parts Catalyst 150 to 100 parts 20-3065 NC resin.
- 2. Pour and cure at room temperature overnight or for 2 hours @ 66°C (155°F).

# HEAT CURING WITH CATALYST 30 (Recommended for higher operating temperature and physical property applications):

Catalyst 30 is designed for applications requiring the optimum in electrical insulation, physical, and thermal properties.

- 1. By weight, thoroughly mix 15 parts Catalyst 30 to 100 parts 20-3065 NC resin.
- 2. Pour and cure according to one of the following recommended cure schedules:
  - a) 85°C (185°F) 3-4 hours
  - b) 100°C (212°F) 2-3 hours

For optimum performance, an additional 2 hours @ 365°F (185°C) is recommended.

#### **IMPORTANT:**

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